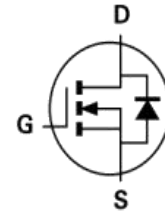


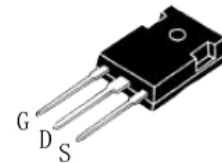
MAIN CHARACTERISTICS

I_D	80A
V_{DSS}	250V
$R_{DS(on)-typ}$ (@ $V_{GS}=10V$)	18.5mΩ



FEATURES

- Proprietary New Trench Technology
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode



TO-247

APPLICATIONS

- Hard Switching and High Speed Circuit
- Motor Control
- UPS

MECHANICAL DATA

- Case: Molded plastic
- Mounting Position: Any
- Molded Plastic: UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106

Product specification classification

Part Number	Package	Mode Name	Pack
LG80N25AB	TO-247	LG80N25AB	Tape

Maximum Ratings at $T_c=25^{\circ}\text{C}$ unless otherwise specified

Characteristics	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	250	V
Gate-Source Voltage	V_{GS}	± 20	V
Continue Drain Current	I_D	80	A
Pulsed Drain Current (Note1)	I_{DM}	320	A
Power Dissipation	P_D	250	W
Single Pulse Avalanche Energy (Note1)	E_{AS}	2000	mJ
Operating Temperature Range	T_J	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^{\circ}\text{C}$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.5	$^{\circ}\text{C/W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	62	$^{\circ}\text{C/W}$

Note1:Pulse test: 300 μs pulse width, 2 % duty cycle

Electrical Characteristics at $T_c=25^{\circ}\text{C}$ unless otherwise specified

Characteristics	Test Condition	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	BV_{DSS}	250	-	-	V
Drain-Source Leakage Current	$V_{DS} = 250\text{ V}, V_{GS} = 0\text{ V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	$V_{GS(th)}$	2.5	-	4.5	V
Drain-Source On-State Resistance	$V_{GS} = 10\text{ V}, I_D = 35\text{ A}$	$R_{DS(on)}$	-	18.5	22	m Ω
Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 125\text{ V}, f = 1\text{ MHz}$	C_{iss}	-	6894	-	pF
Output Capacitance		C_{oss}	-	323	-	pF
Reverse Transfer Capacitance		C_{rss}	-	5.4	-	pF
Turn-on Delay Time(Note2)	$V_{GS}=10\text{ V}, V_{DD}=125\text{ V}, R_G=4.7\text{ }\Omega, I_D=40\text{ A}$	$t_{d(ON)}$	-	38.4	-	ns
Rise Time(Note2)		t_r	-	15.7	-	ns
Turn-Off Delay Time(Note2)		$t_{d(OFF)}$	-	45	-	ns
Fall Time(Note2)		t_f	-	10.8	-	ns
Total Gate Charge(Note2)	$I_D = 40\text{ A}, V_{DD} = 125\text{ V}, V_{GS} = 10\text{ V}$	Q_G	-	80.8	-	nC
Gate to Source Charge(Note2)		Q_{GS}	-	36	-	nC
Gate to Drain Charge(Note2)		Q_{GD}	-	10.7	-	nC

Source-Drain Diode Characteristics at $T_a=25^{\circ}\text{C}$ unless otherwise specified

Characteristics	Test Condition	Symbol	Min.	Typ.	Max.	Unit
Maximun Body-Diode Continuous Current		I_S	-	-	80	A
Maximun Body-Diode Pulsed Current(Note2)		I_{SM}	-	-	320	A
Drain-Source Diode Forward Voltage	$I_{SD} = 50\text{ A}$	V_{SD}	-	-	1.2	V
Reverse Recovery Time(Note2)	$I_{SD} = 40\text{ A}, V_{GS} = 0\text{ V}, dI_F / dt = 100\text{ A}/\mu\text{s}$	t_{rr}	-	232	-	ns
Reverse Recovery Charge(Note2)		Q_{rr}	-	991	-	nC

Note2:Pulse test: 300 μs pulse width, 2 % duty cycle

RATINGS AND CHARACTERISTIC CURVES

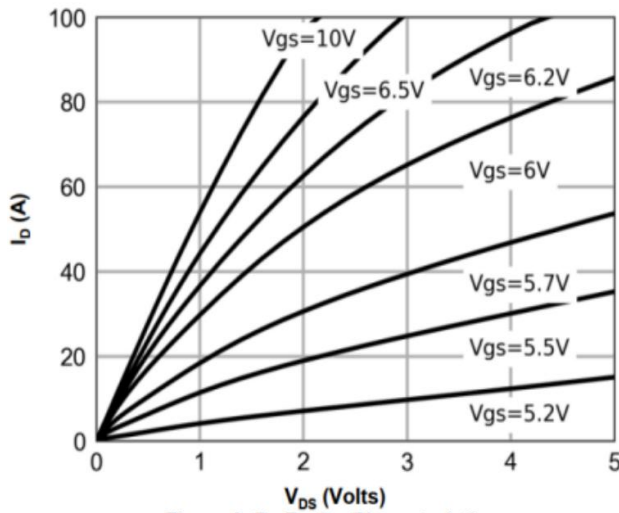


Figure 1: On-Region Characteristics

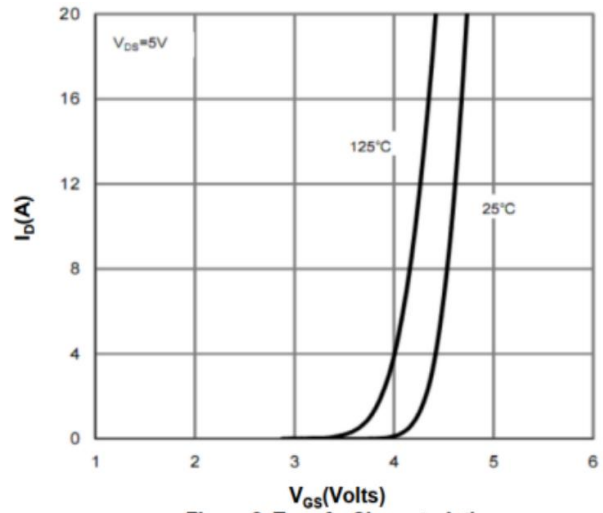


Figure 2: Transfer Characteristics

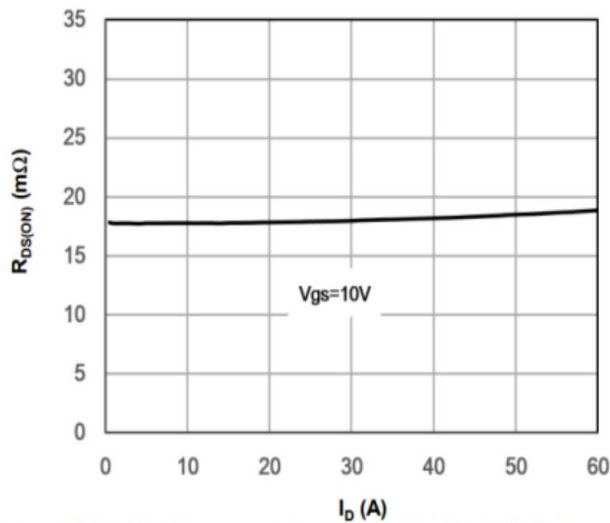


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

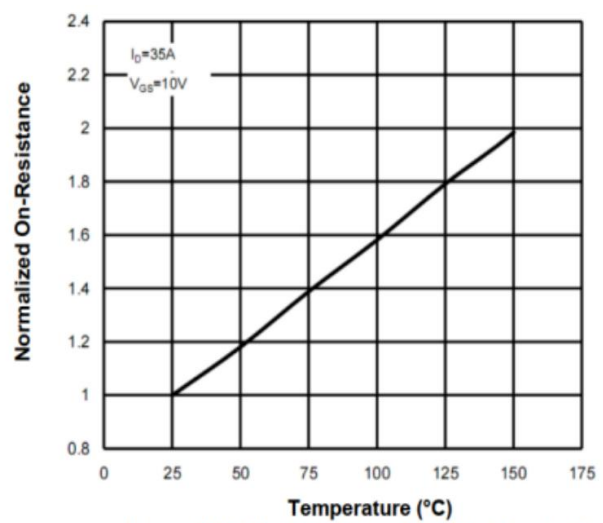


Figure 4: On-Resistance vs. Junction Temperature

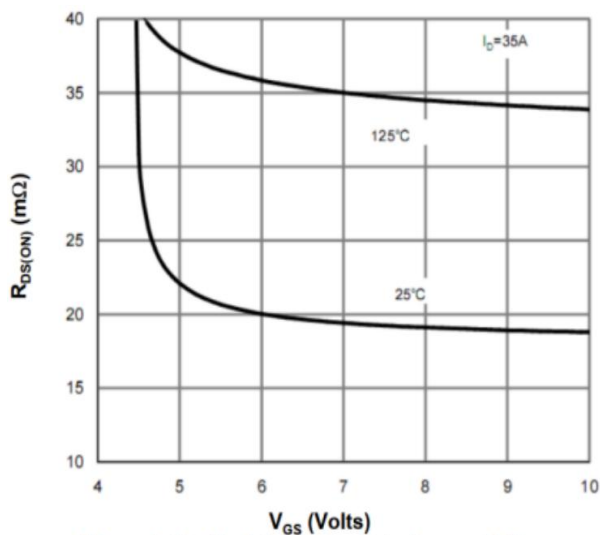


Figure 5: On-Resistance vs. Gate-Source Voltage

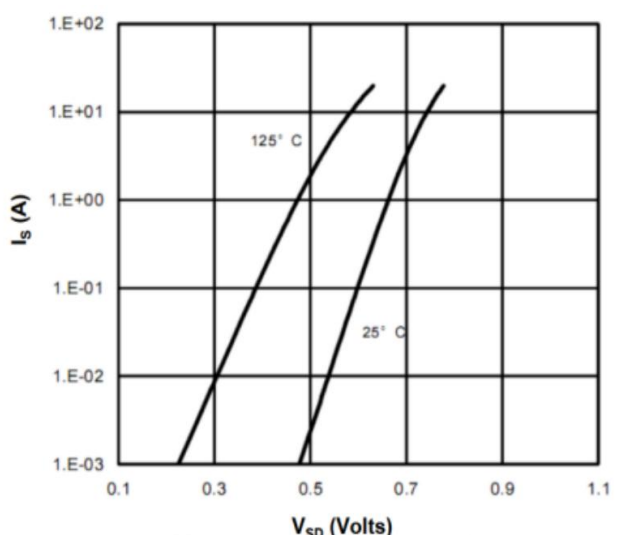
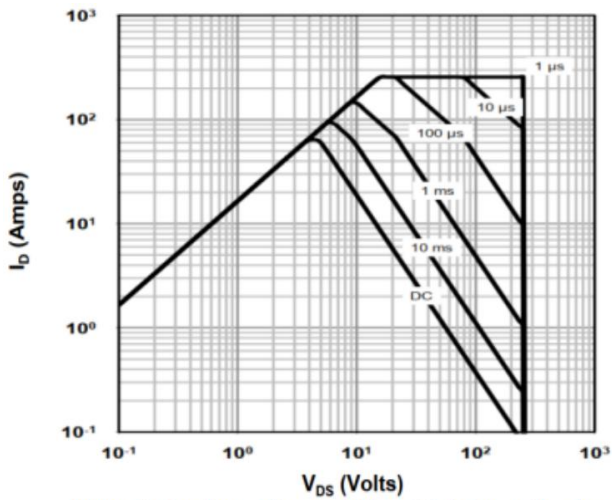
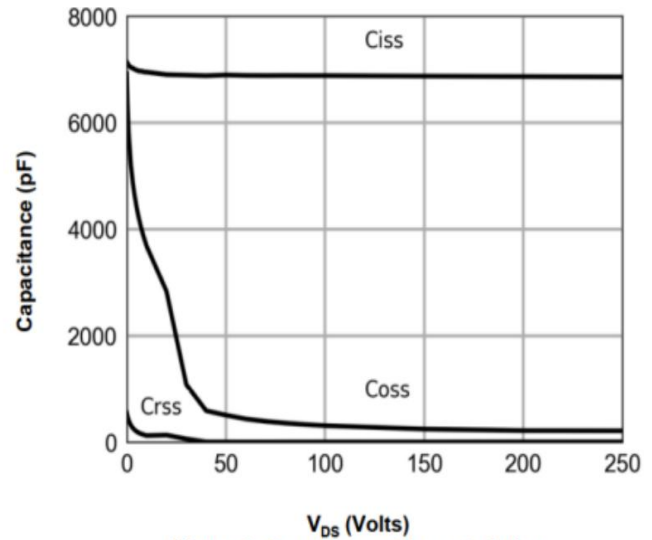
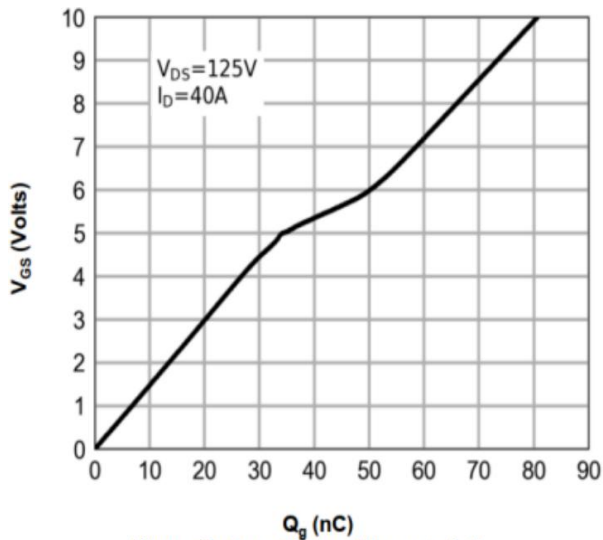


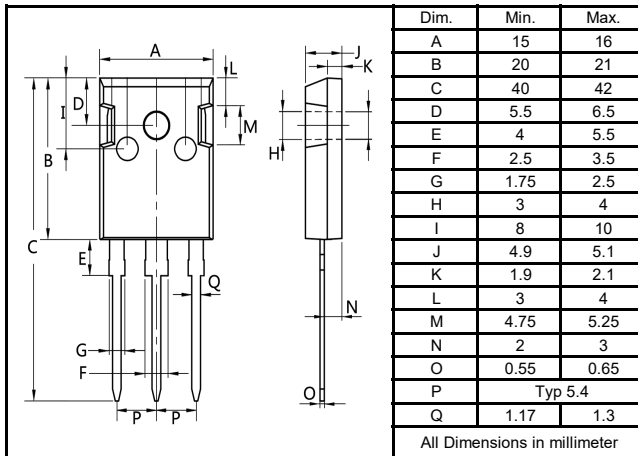
Figure 6: Body-Diode Characteristics

RATINGS AND CHARACTERISTIC CURVES

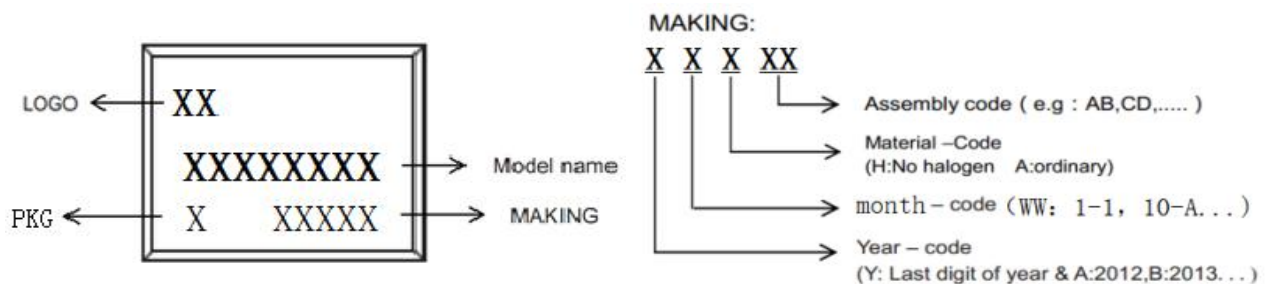


Package Outline Dimensions millimeters

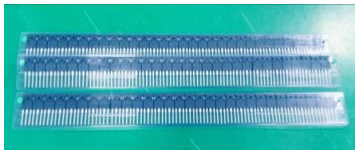
TO-247



Marking on the body



packing instruction

PKG	最小包装	内盒	外箱
TO-247			
	30pcs/管	600pcs/盒	3000pcs/箱

Notice

All product,product specifications and data are subject to change without notice to improve.The right to explain is owned by LINGXUN electronics company.

Confirm that operation temperature is within the specified range described in the product specification. Avoid applying poer exceeding normal ratedpoer; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

LINGXUN electronics shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this documentpoer; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.